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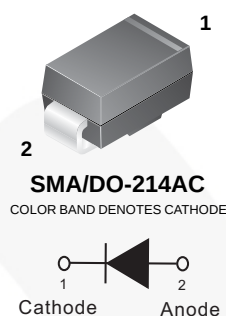
January 2016

## US2AA - US2MA Super Fast Surface Mount Rectifiers

### Features

- Glass Passivated Chip Junction
- High Surge Capacity
- Low Forward Voltage Drop
- Fast Switching with Reverse Recovery Time: 50~75 ns Maximum
- UL Flammability 94V-0 Classification
- MSL 1 per J-STD-020
- RoHS Compliant / Green Molding Compound
- Industrial Device Qualified per AEC-Q101 Standards

\* See authorized use policy



### Ordering Information

| Part Number | Top Mark | Package        | Packing Method |
|-------------|----------|----------------|----------------|
| US2AA       | US2AA    | DO-214AC (SMA) | Tape and Reel  |
| US2BA       | US2BA    | DO-214AC (SMA) | Tape and Reel  |
| US2DA       | US2DA    | DO-214AC (SMA) | Tape and Reel  |
| US2FA       | US2FA    | DO-214AC (SMA) | Tape and Reel  |
| US2GA       | US2GA    | DO-214AC (SMA) | Tape and Reel  |
| US2JA       | US2JA    | DO-214AC (SMA) | Tape and Reel  |
| US2KA       | US2KA    | DO-214AC (SMA) | Tape and Reel  |
| US2MA       | US2MA    | DO-214AC (SMA) | Tape and Reel  |

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol      | Parameter                                                                                  | Value       |        |        |        |        |        |        |        | Unit             |
|-------------|--------------------------------------------------------------------------------------------|-------------|--------|--------|--------|--------|--------|--------|--------|------------------|
|             |                                                                                            | US2 AA      | US2 BA | US2 DA | US2 FA | US2 GA | US2 JA | US2 KA | US2 MA |                  |
| $V_{RRM}$   | Repetitive Peak Reverse Voltage                                                            | 50          | 100    | 200    | 300    | 400    | 600    | 800    | 1000   | V                |
| $V_{RMS}$   | RMS Reverse Voltage                                                                        | 35          | 70     | 140    | 210    | 280    | 420    | 560    | 700    | V                |
| $V_{DC}$    | DC Blocking Voltage                                                                        | 50          | 100    | 200    | 300    | 400    | 600    | 800    | 1000   | V                |
| $I_{F(AV)}$ | Average Forward Rectified Current                                                          | 1.5         |        |        |        |        |        |        |        | A                |
| $I_{FSM}$   | Peak Forward Surge Current,<br>8.3 ms Single Half-Sine Wave,<br>Superimposed on Rated Load | 50          |        |        |        |        |        |        |        | A                |
| $T_J$       | Operating Junction Temperature Range                                                       | -55 to +150 |        |        |        |        |        |        |        | $^\circ\text{C}$ |
| $T_{STG}$   | Storage Temperature Range                                                                  | -55 to +150 |        |        |        |        |        |        |        | $^\circ\text{C}$ |

## Thermal Characteristics<sup>(1)</sup>

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol          | Parameter                                                                            | Value | Unit               |
|-----------------|--------------------------------------------------------------------------------------|-------|--------------------|
| $R_{\theta JA}$ | Typical Thermal Resistance, Junction-to-Ambient                                      | 189   | $^\circ\text{C/W}$ |
| $\Psi_{JL}$     | Typical Thermal Characteristics, Junction-to-Lead<br>(with Reference to Cathode Pin) | 31    | $^\circ\text{C/W}$ |

### Note:

1. Device mounted at minimum pad.

## Electrical Characteristics

Values are at  $T_A = 25^\circ\text{C}$  unless otherwise noted.

| Symbol          | Parameter                                                                         |                        | Value     |           |           |           |           |           |           |           | Unit |
|-----------------|-----------------------------------------------------------------------------------|------------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|------|
|                 |                                                                                   |                        | US2<br>AA | US2<br>BA | US2<br>DA | US2<br>FA | US2<br>GA | US2<br>JA | US2<br>KA | US2<br>MA |      |
| V <sub>F</sub>  | Maximum Instantaneous Forward Voltage <sup>(2)</sup><br>at I <sub>F</sub> = 1.5 A |                        | 1.0       |           |           |           | 1.3       | 1.7       |           | V         |      |
| I <sub>R</sub>  | Maximum Reverse Current<br>at Rated V <sub>R</sub>                                | T <sub>J</sub> = 25°C  | 5         |           |           |           |           |           |           |           | μA   |
|                 |                                                                                   | T <sub>J</sub> = 125°C | 100       |           |           |           |           |           |           |           |      |
| T <sub>rr</sub> | Maximum Reverse Recovery Time <sup>(3)</sup>                                      |                        | 50        |           |           |           | 75        |           | ns        |           |      |
| C <sub>J</sub>  | Typical Junction Capacitance <sup>(4)</sup>                                       |                        | 50        |           |           |           | 30        |           | pF        |           |      |

### Notes:

2. Pulse test with  $PW = 300\text{ }\mu\text{s}$ , 1% duty cycle
3. Reverse recovery test conditions:  $I_F = 0.5\text{ A}$ ,  $I_R = 1.0\text{ A}$ ,  $I_{RR} = 0.25\text{ A}$
4. Measured at 1 MHz and applied reverse voltage of 4.0 V D.C.

## Typical Performance Characteristics

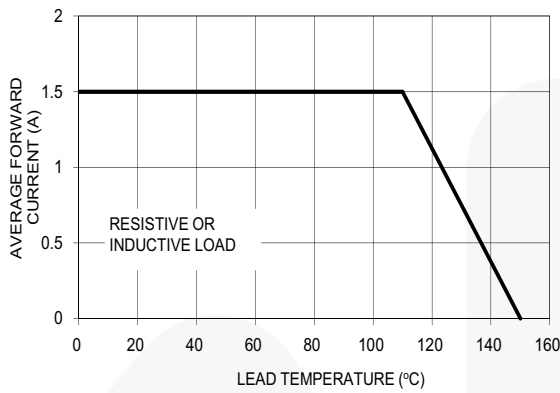


Figure 1. Forward Current Derating Curve

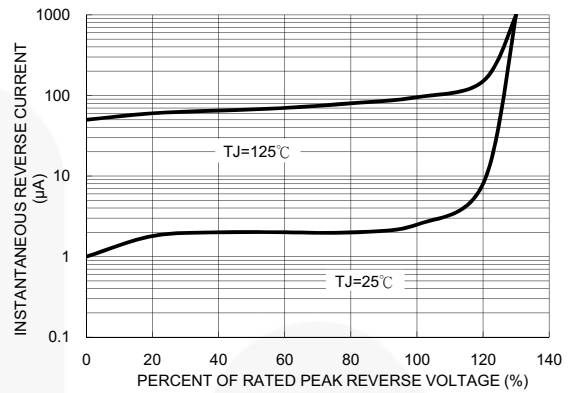


Figure 2. Typical Reverse Characteristics

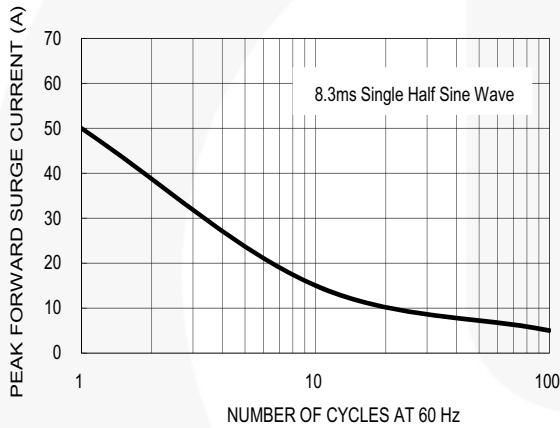


Figure 3. Maximum Non-Repetitive Forward Surge Current

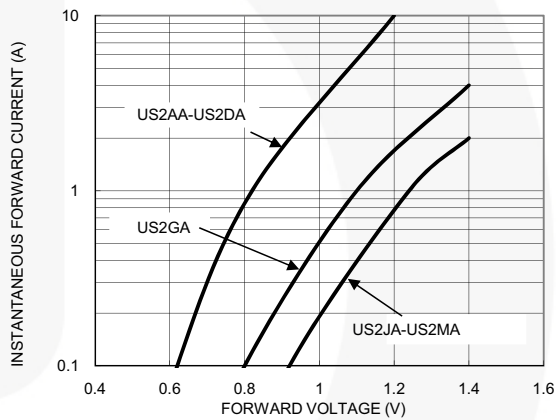


Figure 4. Typical Forward Characteristics

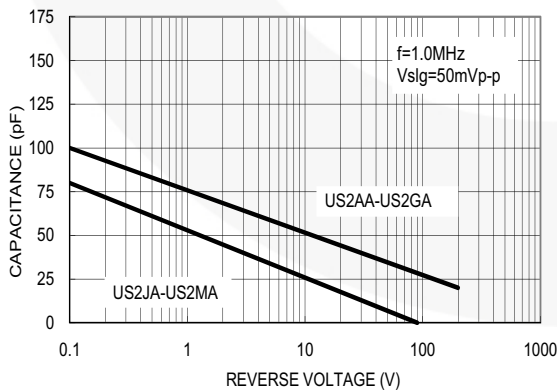


Figure 5. Typical Junction Capacitance

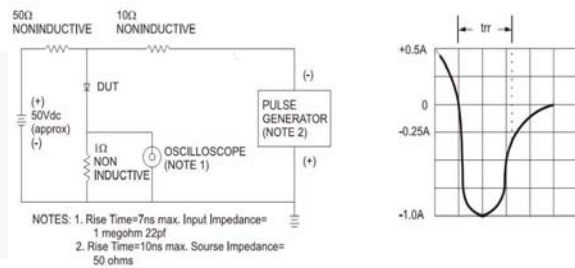
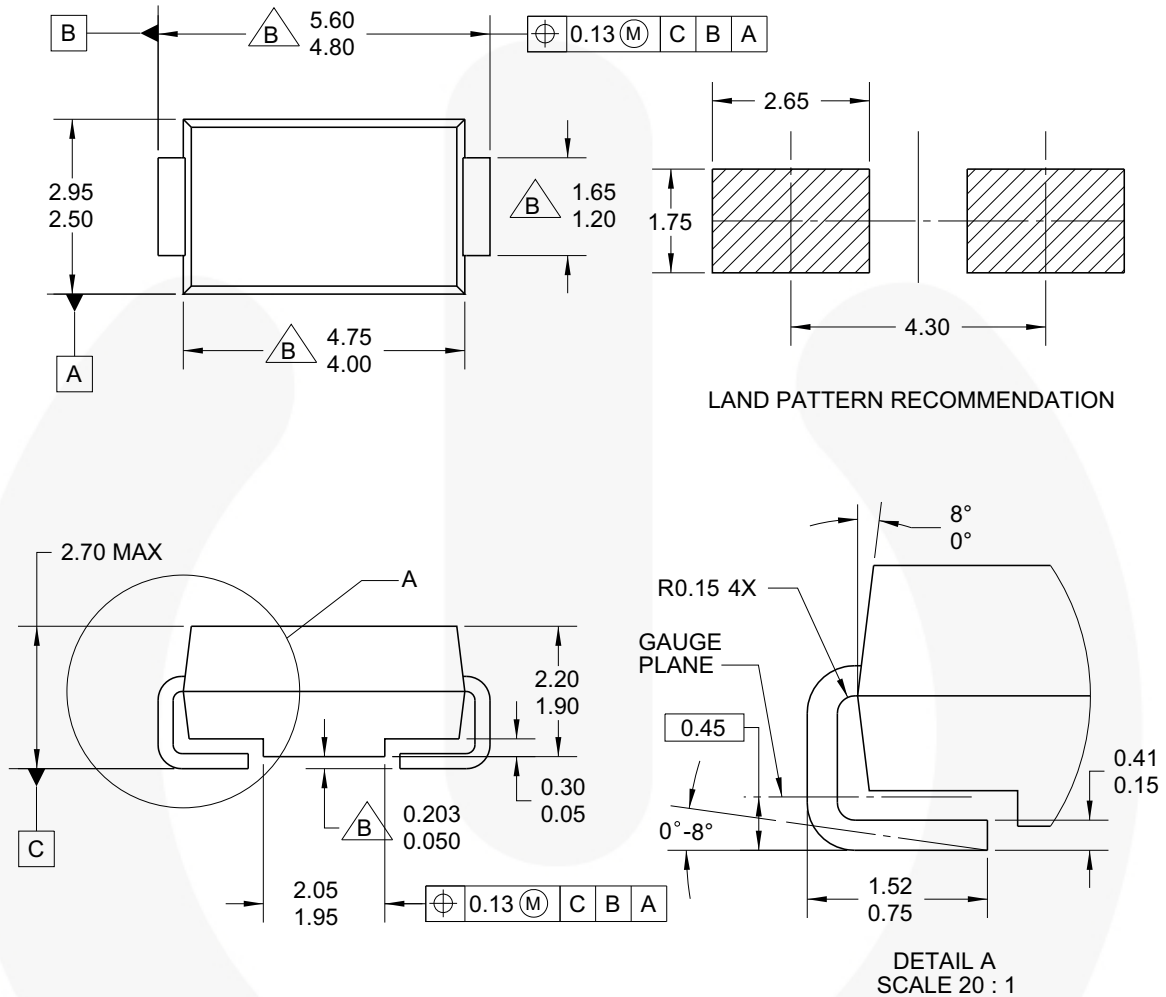


Figure 6. Reverse Recovery Time Characteristic and Test Circuit Diagram

# Physical Dimensions



## NOTES:

- EXCEPT WHERE NOTED CONFORMS TO JEDEC DO214 VARIATION AC.
- DOES NOT COMPLY JEDEC STD. VALUE.
- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
- LAND PATTERN STD. DIOM5025X231M.
- DRAWING FILE NAME: DO214ACREV1

Figure 7. 2-Lead, SMA, JEDEC DO-214, VARIATION AC



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